

Curing Behavior, Rheological, and Thermal Properties of DGEBA Modified with Synthesized BPA/PEG Hyperbranched Epoxy after Their Photo-Initiated Cationic Polymerization

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Supplementary Material

Table 1. The density of each sample cured at various UV intensity.

UV intensity (mW/cm ²)	Density (g/cm ³)	
	DGEBA	D90H10
10	1.0000 ± 2×10 ⁻⁶	1.0000 ± 1×10 ⁻⁵
20	1.0000 ± 9×10 ⁻⁸	1.0000 ± 5×10 ⁻⁶
30	1.0000 ± 1×10 ⁻⁵	1.0000 ± 5×10 ⁻⁶
40	1.0000 ± 1×10 ⁻⁵	1.0000 ± 5×10 ⁻⁶
50	1.0002 ± 4×10 ⁻⁴	1.0002 ± 3×10 ⁻⁴

Table 2. Parameters from Zimm plot for DGEBA and D90H10 at various UV intensity.

UV intensity (mW/cm ²)	Slope	Intercept	I ₀	ξ (nm)	R _g (nm)
DGEBA					
10	55.547 ± 0.440	0.009 ± 0.000	108.042 ± 1.349	7.747 ± 0.079	13.42 ± 0.14
20	54.391 ± 0.004	0.021 ± 0.000	48.567 ± 0.000	5.140 ± 0.000	8.90 ± 0.00
30	39.715 ± 0.063	0.027 ± 0.000	37.290 ± 0.021	3.848 ± 0.004	6.67 ± 0.01
40	45.547 ± 0.344	0.024 ± 0.000	41.289 ± 0.148	4.337 ± 0.024	7.51 ± 0.04
50	45.315 ± 0.003	0.024 ± 0.000	40.866 ± 0.000	4.303 ± 0.000	7.45 ± 0.00
D90H10					
10	52.440 ± 0.004	0.022 ± 0.000	44.783 ± 0.000	4.846 ± 0.000	8.39 ± 0.00
20	54.257 ± 0.004	0.020 ± 0.000	50.454 ± 0.000	5.232 ± 0.000	9.06 ± 0.00
30	66.274 ± 1.067	0.006 ± 0.000	176.712 ± 9.418	10.821 ± 0.377	18.74 ± 0.65
40	60.648 ± 0.004	0.016 ± 0.000	64.350 ± 0.000	6.247 ± 0.000	10.82 ± 0.00
50	58.156 ± 0.005	0.023 ± 0.000	44.131 ± 0.000	5.066 ± 0.000	8.77 ± 0.00

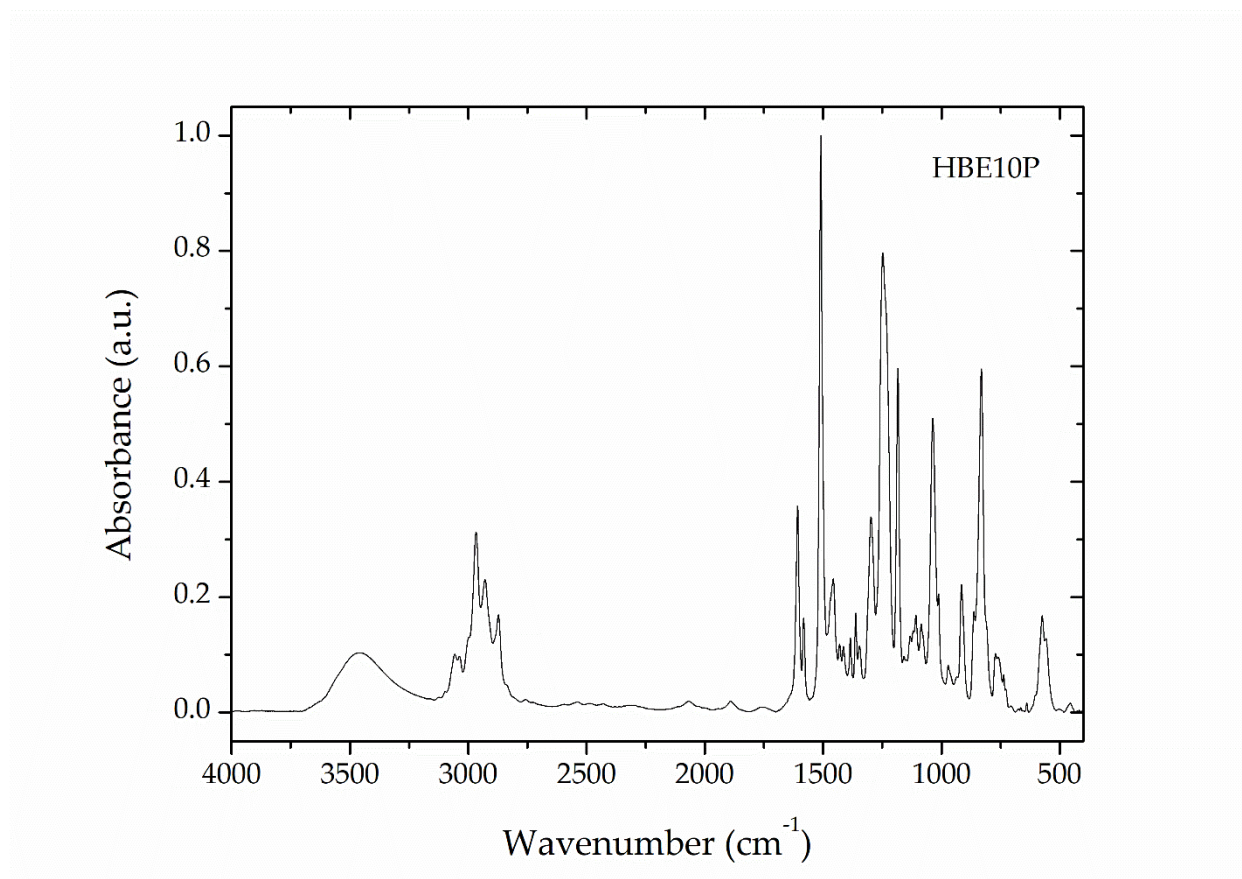


Figure 1. FTIR spectra of HBE10P resin.

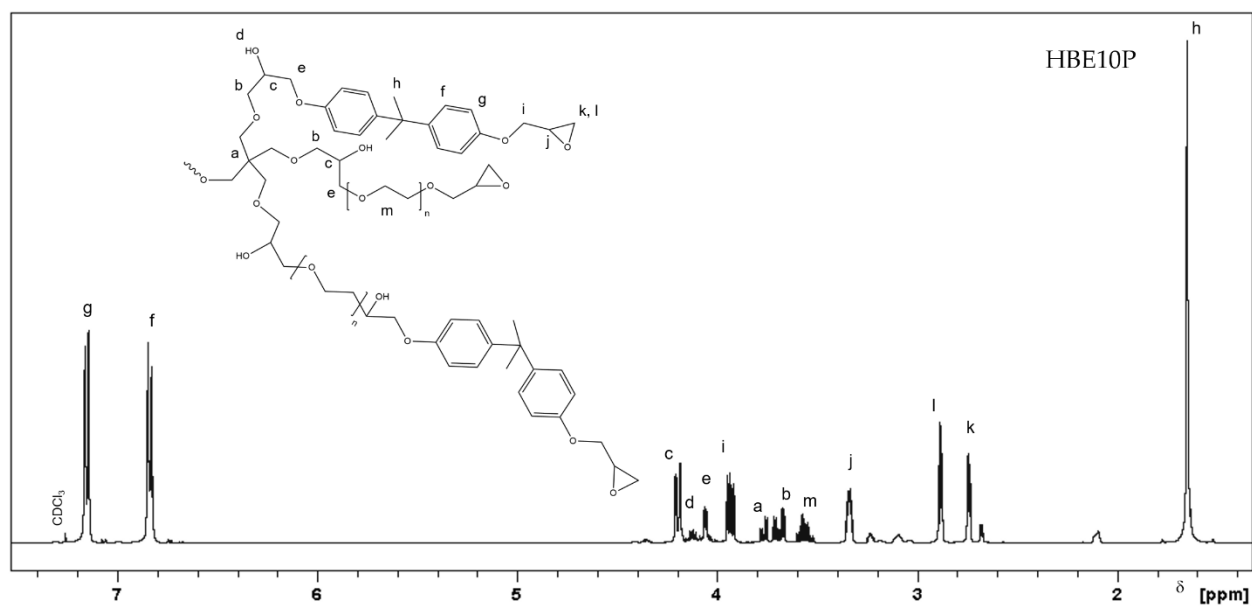


Figure 2. ¹H NMR spectrum of HBE10P resin.

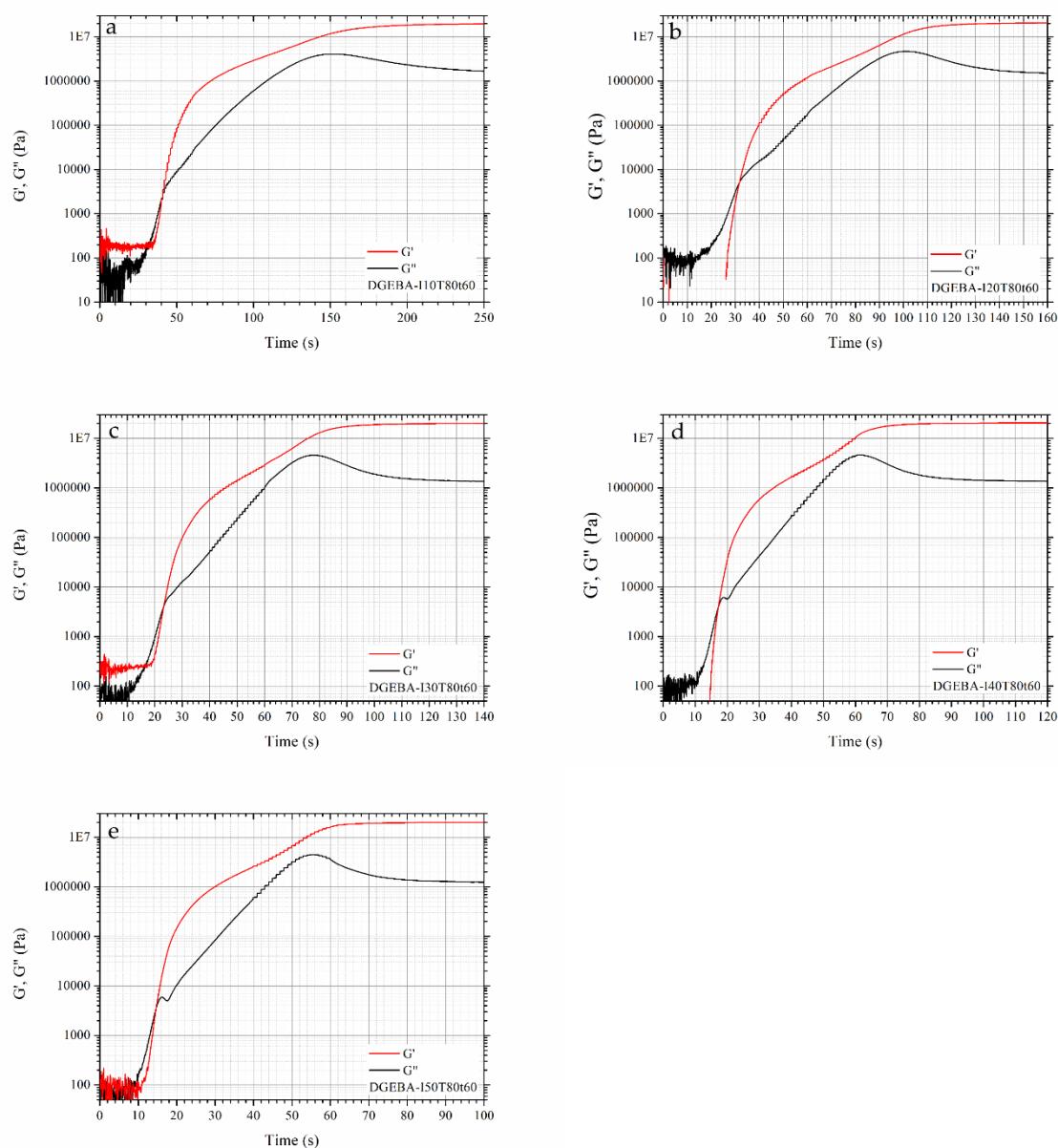


Figure 3. Crossover of storage modulus (G') and loss modulus (G'') of DGEBA system at various curing conditions: (a) 10 mW/cm² (b) 20 mW/cm² (c) 30 mW/cm² (d) 40 mW/cm² and (e) 50 mW/cm².

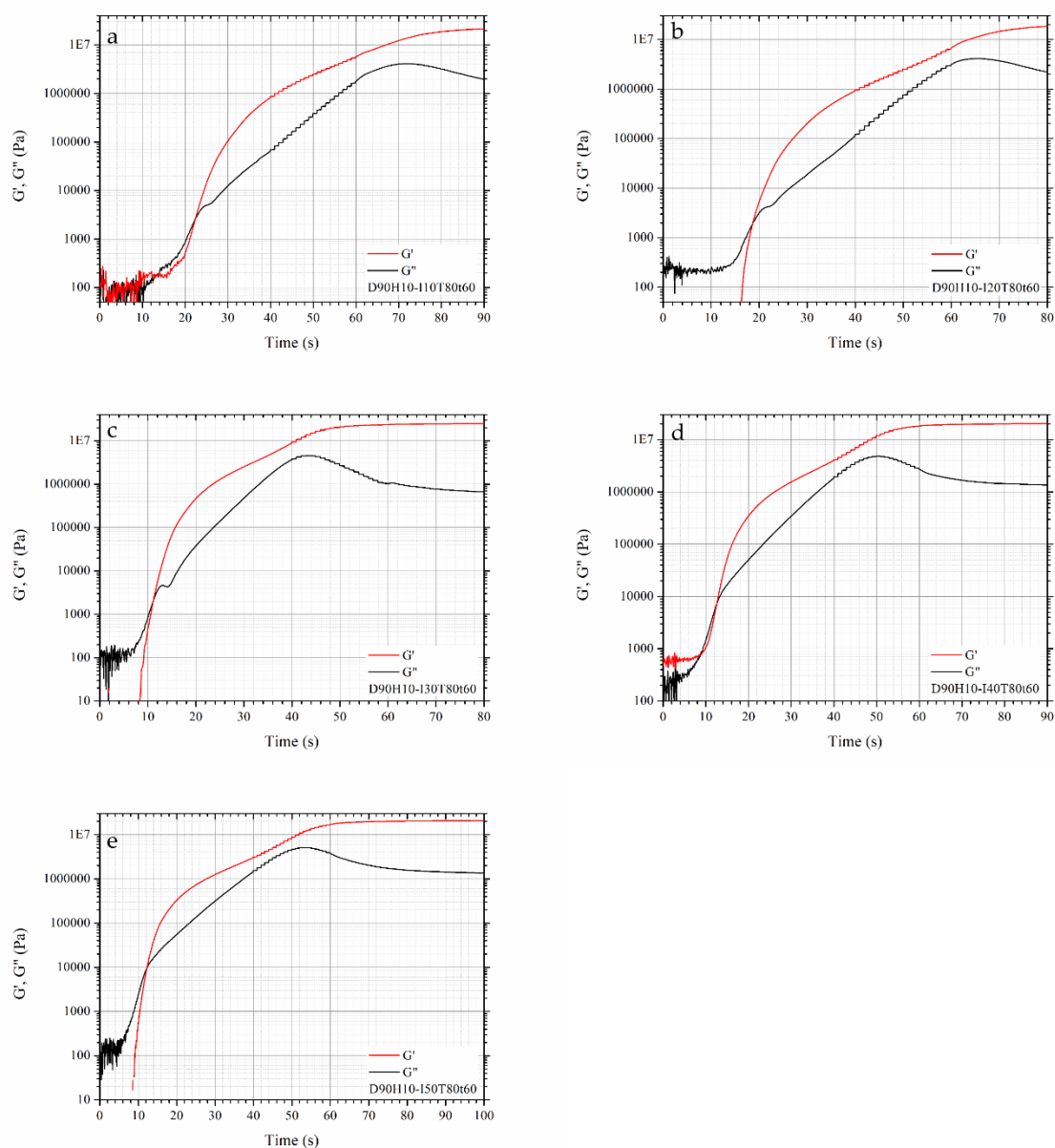


Figure 4. Crossover of storage modulus (G') and loss modulus (G'') of D90H10 system at various curing conditions: (a) 10 mW/cm² (b) 20 mW/cm² (c) 30 mW/cm² (d) 40 mW/cm² and (e) 50 mW/cm².

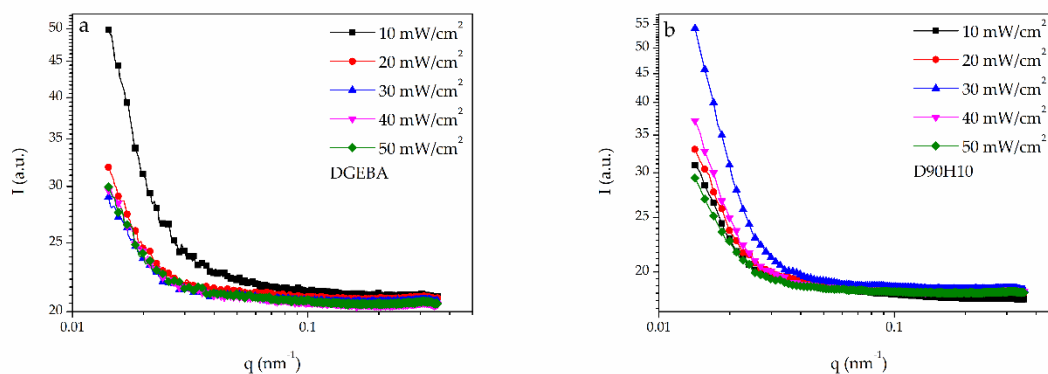


Figure 5. SAXS profiles of (a) DGEBA and (b) D90H10 cured at various UV intensity.



Figure 6. (a) DSC and (b) Rheometer instruments equipped with UV light guide.

Abbreviations

DGEBA	Diglycidyl ether of bisphenol A
BPA	Bisphenol A
PEG	Polyethylene glycol
HBE10P	Hyperbranched epoxy resin consisting of 10 wt% PEG
D90H10	Resin having DGEBA and HBE10P ratio to 90:10 wt/wt
ACE	Activated chain end mechanism
AM	Activated monomer mechanism
DSC	Differential scanning calorimetry
UV	Ultraviolet
SAXS	Small-angle X-ray scattering (SAXS)
RB	Round-bottom flask having a spherical bottom